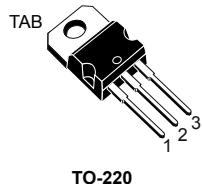


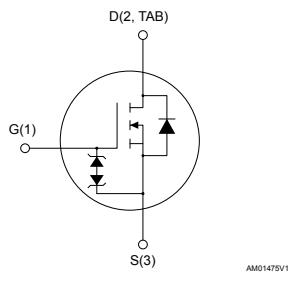
N-channel 600 V, 68 mΩ typ., 36 A, MDmesh M6 Power MOSFET in a TO-220 package

Features



Order code	V _{DS}	R _{DS(on)} max.	I _D
STP46N60M6	600 V	80 mΩ	36 A

- Reduced switching losses
- Lower R_{DS(on)} per area vs previous generation
- Low gate input resistance
- 100% avalanche tested
- Zener-protected



Applications

- Switching applications
- LLC converters
- Boost PFC converters

Description

The new MDmesh M6 technology incorporates the most recent advancements to the well-known and consolidated MDmesh family of SJ MOSFETs. STMicroelectronics builds on the previous generation of MDmesh devices through its new M6 technology, which combines excellent R_{DS(on)} per area improvement with one of the most effective switching behaviors available, as well as a user-friendly experience for maximum end-application efficiency.



Product status link

[STP46N60M6](#)

Product summary

Order code	STP46N60M6
Marking	46N60M6
Package	TO-220
Packing	Tube

1

Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{GS}	Gate-source voltage	± 25	V
I_D	Drain current (continuous) at $T_{case} = 25 \text{ }^\circ\text{C}$	36	A
	Drain current (continuous) at $T_{case} = 100 \text{ }^\circ\text{C}$	23	
$I_D^{(1)}$	Drain current (pulsed)	126	A
P_{TOT}	Total power dissipation at $T_{case} = 25 \text{ }^\circ\text{C}$	250	W
$dv/dt^{(2)}$	Peak diode recovery voltage slope	15	V/ns
	MOSFET dv/dt ruggedness	100	
T_{stg}	Storage temperature range	-55 to 150	$^\circ\text{C}$
T_j	Operating junction temperature range		

1. Pulse width limited by safe operating area.
2. $I_{SD} \leq 36 \text{ A}$, $di/dt \leq 400 \text{ A}/\mu\text{s}$, $V_{DS(\text{peak})} < V_{(BR)DSS}$, $V_{DD} = 400 \text{ V}$
3. $V_{DS} \leq 480 \text{ V}$

Table 2. Thermal data

Symbol	Parameter	Value	Unit
$R_{thj-case}$	Thermal resistance junction-case	0.5	$^\circ\text{C}/\text{W}$
$R_{thj-amb}$	Thermal resistance junction-ambient	62.5	$^\circ\text{C}/\text{W}$

Table 3. Avalanche characteristics

Symbol	Parameter	Value	Unit
I_{AR}	Avalanche current, repetitive or non-repetitive (pulse width limited by T_{Jmax})	5.2	A
E_{AS}	Single pulse avalanche energy (starting $T_j = 25 \text{ }^\circ\text{C}$, $I_D = I_{AR}$, $V_{DD} = 50 \text{ V}$)	760	mJ

2 Electrical characteristics

($T_{\text{case}} = 25^\circ\text{C}$ unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(\text{BR})\text{DSS}}$	Drain-source breakdown voltage	$V_{\text{GS}} = 0 \text{ V}$, $I_D = 1 \text{ mA}$	600			V
I_{DSS}	Zero gate voltage drain current	$V_{\text{GS}} = 0 \text{ V}$, $V_{\text{DS}} = 600 \text{ V}$			1	μA
		$V_{\text{GS}} = 0 \text{ V}$, $V_{\text{DS}} = 600 \text{ V}$, $T_{\text{case}} = 125^\circ\text{C}^{(1)}$			100	
I_{GSS}	Gate-body leakage current	$V_{\text{DS}} = 0 \text{ V}$, $V_{\text{GS}} = \pm 25 \text{ V}$			± 5	μA
$V_{\text{GS}(\text{th})}$	Gate threshold voltage	$V_{\text{DS}} = V_{\text{GS}}$, $I_D = 250 \mu\text{A}$	3.25	4	4.75	V
$R_{\text{DS}(\text{on})}$	Static drain-source on-resistance	$V_{\text{GS}} = 10 \text{ V}$, $I_D = 18 \text{ A}$		68	80	$\text{m}\Omega$

1. Defined by design, not subject to production test.

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{iss}	Input capacitance	$V_{\text{DS}} = 100 \text{ V}$, $f = 1 \text{ MHz}$, $V_{\text{GS}} = 0 \text{ V}$	-	2340	-	pF
C_{oss}	Output capacitance		-	147	-	
C_{rss}	Reverse transfer capacitance		-	3.7	-	
$C_{\text{oss eq.}}^{(1)}$	Equivalent output capacitance	$V_{\text{DS}} = 0$ to 480 V , $V_{\text{GS}} = 0 \text{ V}$	-	339	-	pF
R_G	Intrinsic gate resistance	$f = 1 \text{ MHz}$, $I_D = 0 \text{ A}$	-	1.6	-	Ω
Q_g	Total gate charge	$V_{\text{DD}} = 480 \text{ V}$, $I_D = 36 \text{ A}$, $V_{\text{GS}} = 0$ to 10 V (see Figure 14. Test circuit for gate charge behavior)	-	53.5	-	nC
Q_{gs}	Gate-source charge		-	15.5	-	
Q_{gd}	Gate-drain charge		-	23.5	-	

1. $C_{\text{oss eq.}}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS} .

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{\text{d(on)}}$	Turn-on delay time	$V_{\text{DD}} = 300 \text{ V}$, $I_D = 18 \text{ A}$, $R_G = 4.7 \Omega$, $V_{\text{GS}} = 10 \text{ V}$ (see Figure 13. Test circuit for resistive load switching times and Figure 18. Switching time waveform)	-	20	-	ns
t_r	Rise time		-	15.5	-	
$t_{\text{d(off)}}$	Turn-off delay time		-	48.4	-	
t_f	Fall time		-	8.5	-	

Table 7. Source-drain diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I _{SD}	Source-drain current		-		36	A
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		126	A
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 36 A, V _{GS} = 0 V	-		1.6	V
t _{rr}	Reverse recovery time	I _{SD} = 36 A, di/dt = 100 A/μs, V _{DD} = 60 V	-	267		ns
Q _{rr}	Reverse recovery charge	(see Figure 15. Test circuit for inductive load switching and diode recovery times)	-	2.8		μC
I _{RRM}	Reverse recovery current		-	20.8		A
t _{rr}	Reverse recovery time	I _{SD} = 36 A, di/dt = 100 A/μs, V _{DD} = 60 V, T _j = 150 °C	-	440		ns
Q _{rr}	Reverse recovery charge	(see Figure 15. Test circuit for inductive load switching and diode recovery times)	-	5.8		μC
I _{RRM}	Reverse recovery current		-	26.4		A

1. Pulse width is limited by safe operating area.
2. Pulsed: pulse duration = 300 μs, duty cycle 1.5%

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

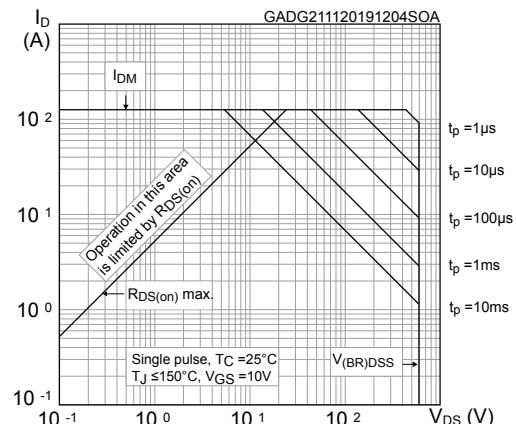


Figure 2. Maximum transient thermal impedance

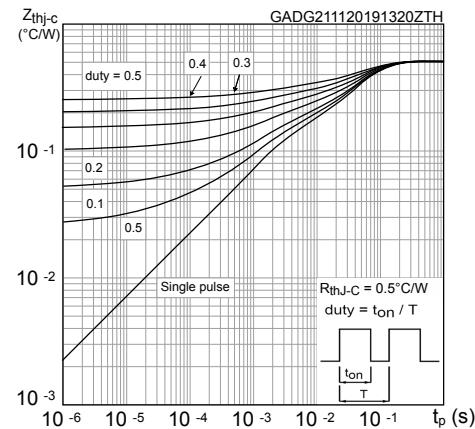


Figure 3. Typical output characteristics

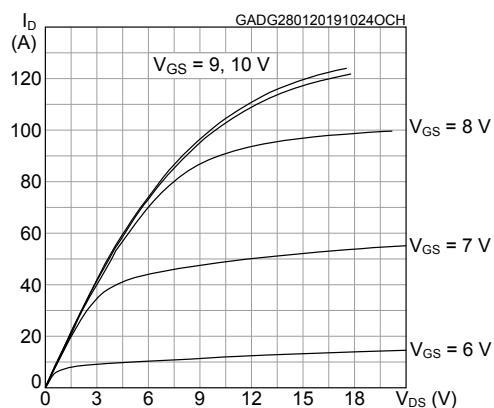


Figure 4. Typical transfer characteristics

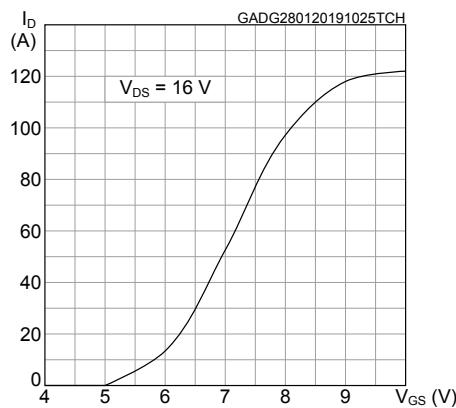


Figure 5. Typical gate charge characteristics

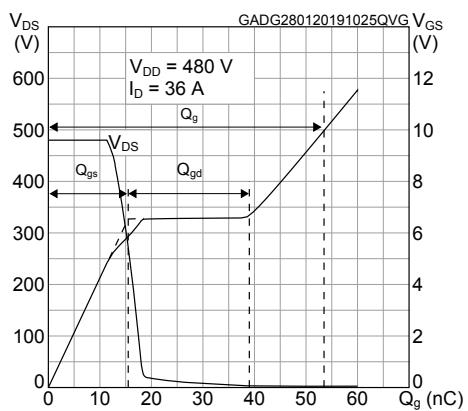


Figure 6. Typical drain-source on-resistance

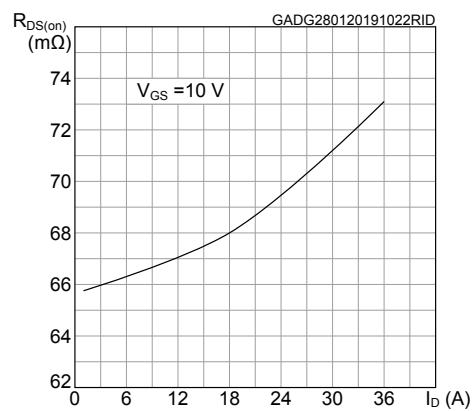
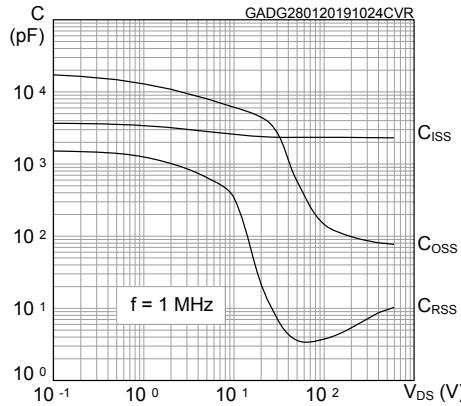
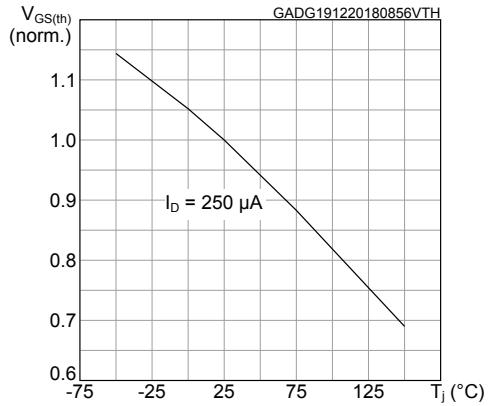
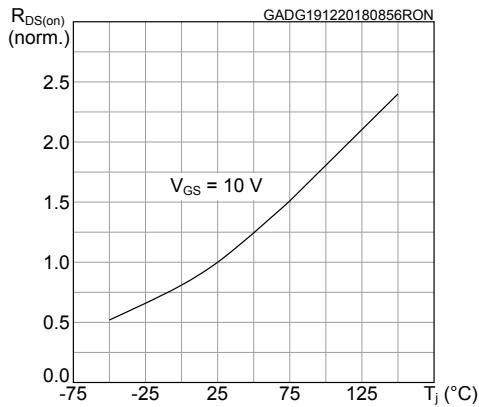
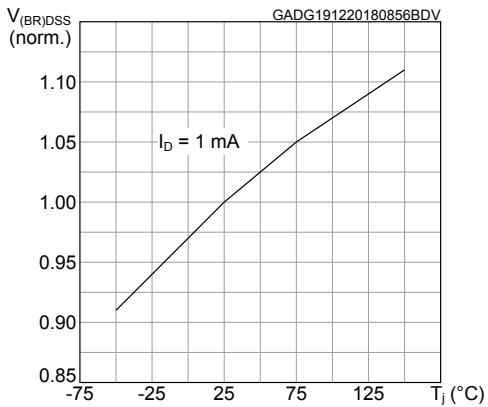
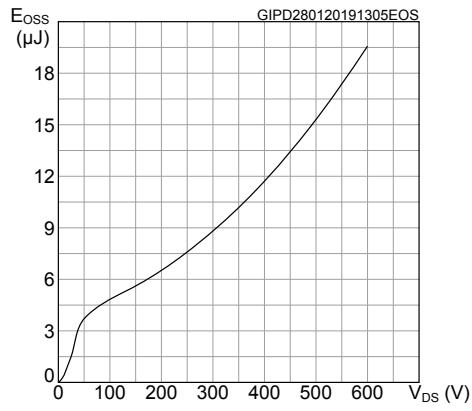
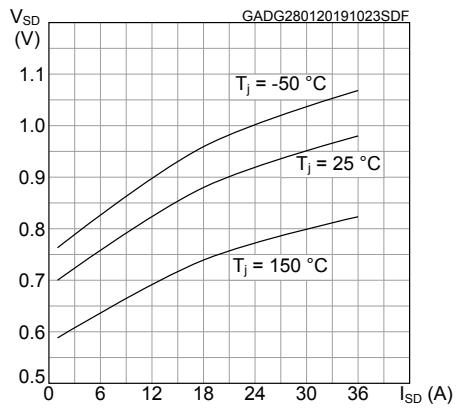
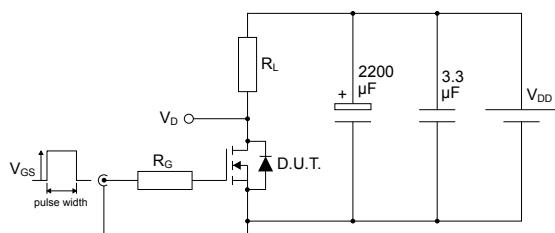


Figure 7. Typical capacitance characteristics

Figure 8. Normalized gate threshold vs temperature

Figure 9. Normalized on-resistance vs temperature

Figure 10. Normalized breakdown voltage vs temperature

Figure 11. Typical output capacitance stored energy

Figure 12. Typical reverse diode forward characteristics


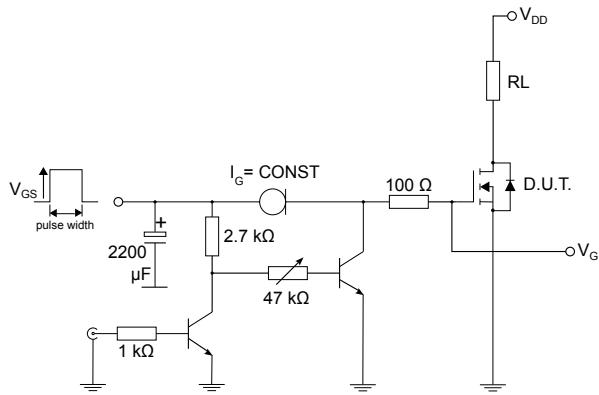
3 Test circuits

Figure 13. Test circuit for resistive load switching times



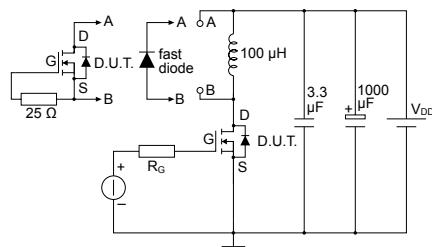
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Figure 14. Test circuit for gate charge behavior



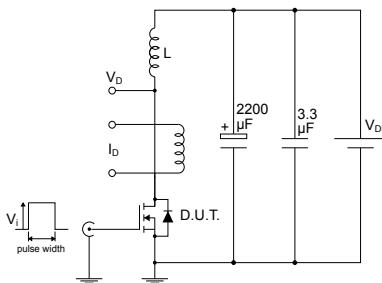
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Figure 15. Test circuit for inductive load switching and diode recovery times



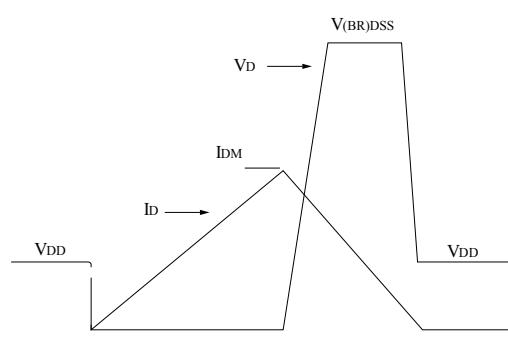
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Figure 16. Unclamped inductive load test circuit



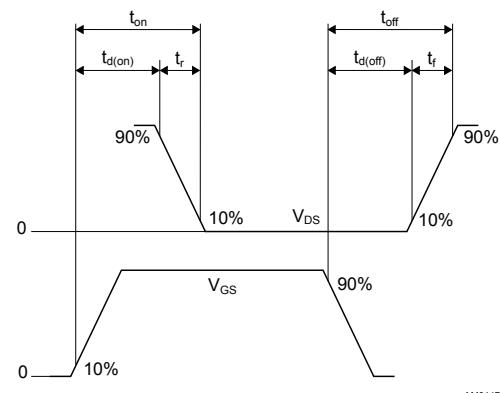
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Figure 17. Unclamped inductive waveform



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Figure 18. Switching time waveform



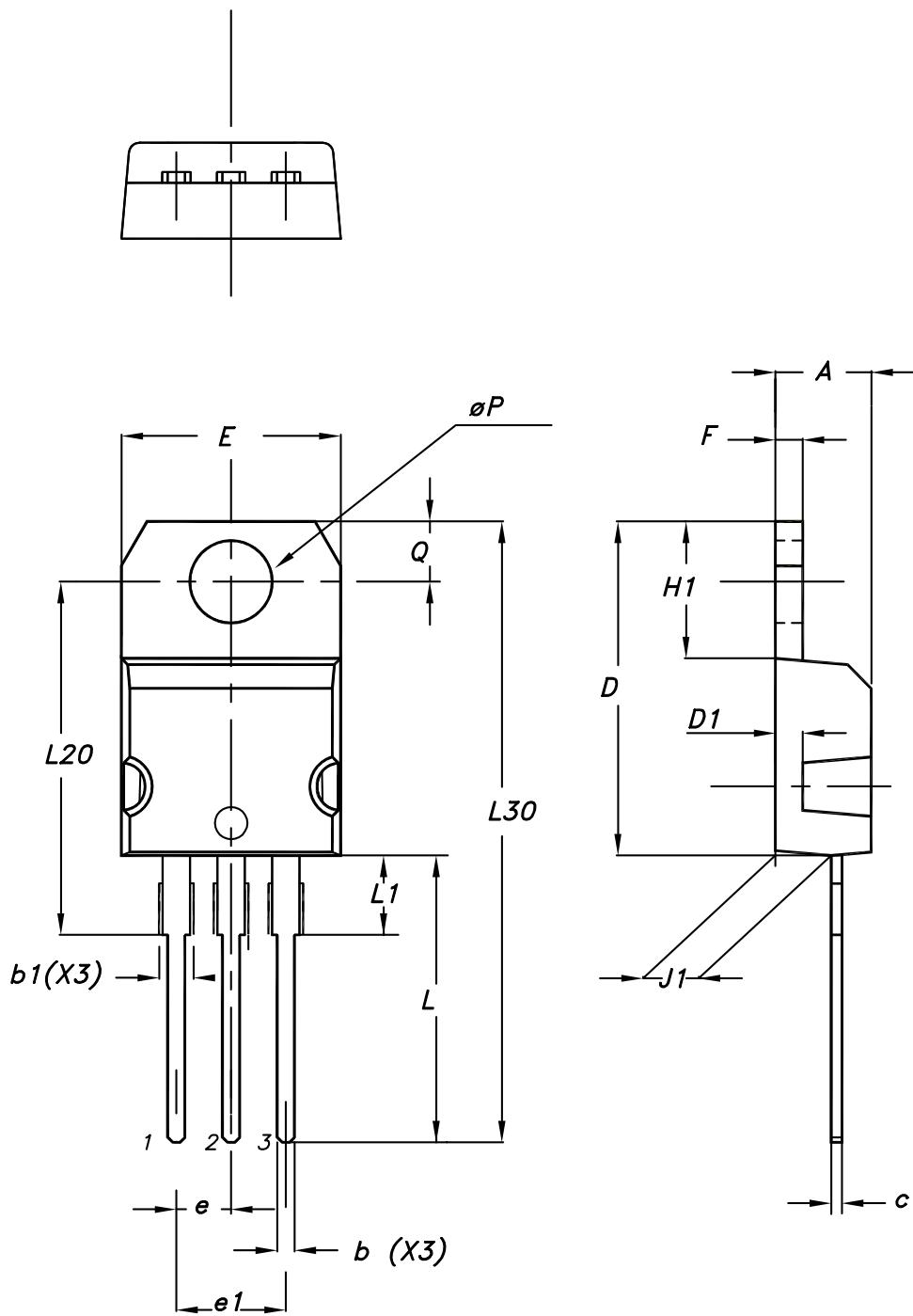
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4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

4.1 TO-220 package information

Figure 19. TO-220 type A package outline



0015988_typeA_Rev_22

Table 8. TO-220 type A package mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.40		4.60
b	0.61		0.88
b1	1.14		1.55
c	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10.00		10.40
e	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13.00		14.00
L1	3.50		3.93
L20		16.40	
L30		28.90	
øP	3.75		3.85
Q	2.65		2.95

Revision history

Table 9. Document revision history

Date	Version	Changes
10-Jan-2018	1	Initial release.
01-Feb-2019	2	Modified Table 1. Absolute maximum ratings, Table 2. Thermal data, Table 3. Avalanche characteristics, Table 4. On/off states, Table 5. Dynamic, Table 6. Switching times and Table 7. Source-drain diode. Modified Figure 14. Test circuit for gate charge behavior. Minor text changes.
22-Nov-2019	3	Updated Table 3. Avalanche characteristics , Table 5. Dynamic and Section 2.1 Electrical characteristics (curves) . Minor text changes.

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